

### **General Description**

The MAX6412-MAX6420 low-power microprocessor supervisor circuits monitor system voltages from 1.6V to 5V. These devices are designed to assert a reset signal whenever the VCC supply voltage or RESET IN falls below its reset threshold or the manual reset input is asserted. The reset output remains asserted for the reset timeout period after VCC and RESET IN rise above the reset threshold and the manual reset input is deasserted. The reset timeout is externally set by a capacitor to provide more flexibility.

The MAX6412/MAX6413/MAX6414 feature fixed thresholds from 1.575V to 5V in approximately 100mV increments and a manual reset input. The MAX6415/MAX6416/MAX6417 are offered with an adjustable reset input that can monitor voltages down to 1.26V and the MAX6418/MAX6419/ MAX6420 are offered with one fixed input and one adjustable input to monitor dual-voltage systems.

The MAX6412/MAX6415/MAX6418 have an active-low, push-pull reset output. The MAX6413/MAX6416/ MAX6419 have an active-high, push-pull reset output and the MAX6414/MAX6417/MAX6420 have an activelow, open-drain reset output. All of these devices are offered in a SOT23-5 package and are fully specified from -40°C to +125°C.

## **Applications**

Automotive

Medical Equipment

Intelligent Instruments

Portable Equipment

Battery-Powered Computers/Controllers

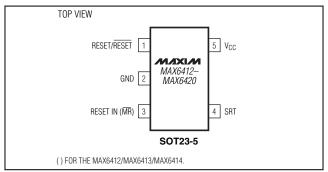
**Embedded Controllers** 

Critical µP Monitoring

**Set-Top Boxes** 

Computers

## Pin Configuration



### **Features**

- ♦ Monitor System Voltages from 1.6V to 5V
- ♦ Capacitor-Adjustable Reset Timeout Period
- ♦ Manual Reset Input (MAX6412/MAX6413/MAX6414)
- **♦ Adjustable Reset Input Option** (MAX6415-MAX6420)
- **♦ Dual-Voltage Monitoring** (MAX6418/MAX6419/MAX6420)
- ♦ Low Quiescent Current (1.7μA, typ)
- ♦ 3 RESET Output Options Push-Pull RESET **Push-Pull RESET Open-Drain RESET**
- ♦ Guaranteed Reset Valid to V<sub>CC</sub> = 1V
- **♦ Power-Supply Transient Immunity**
- ♦ Small SOT23-5 Packages

## **Ordering Information**

PART	TEMP RANGE	PIN-PACKAGE
MAX6412UKT	-40°C to +125°C	5 SOT23
MAX6413UKT	-40°C to +125°C	5 SOT23
MAX6414UKT	-40°C to +125°C	5 SOT23
MAX6415UK-T	-40°C to +125°C	5 SOT23
MAX6416UK-T	-40°C to +125°C	5 SOT23
MAX6417UK-T	-40°C to +125°C	5 SOT23
MAX6418UKT	-40°C to +125°C	5 SOT23
MAX6419UKT	-40°C to +125°C	5 SOT23
MAX6420UKT	-40°C to +125°C	5 SOT23

Note: The MAX6412/MAX6413/MAX6414 and MAX6418/ MAX6419/MAX6420 are available with factory-set V<sub>CC</sub> reset thresholds from 1.575V to 5.0V in approximately 0.1V increments. Insert the desired nominal reset threshold suffix (from Table 1) into the blanks following the letters UK. There are 33 standard versions with a required order increment of 2500 pieces. Sample stock is generally held on standard versions only (see Standard Versions Table). Required order increment is 10,000 pieces for nonstandard versions. Contact factory for availability. All devices are available in tape-and-reel only. Devices are available in both leaded and lead-free packaging. Specify lead-free by replacing "-T" with "+T" when ordering.

Typical Operating Circuit appears at end of data sheet.

Maxim Integrated Products 1

Selector Guide appears at end of data sheet.

### **ABSOLUTE MAXIMUM RATINGS**

All Voltages Referenced to GND	
V <sub>C</sub> C	0.3V to +6.0V
SRT, MR, RESET IN	0.3V to $(V_{CC} + 0.3V)$
RESET, RESET (Push-Pull)	0.3V to (V <sub>CC</sub> + 0.3V)
RESET (Open-Drain)	0.3V to +6.0V
Input Current (All Pins)	±20mA
Output Current (RESET, RESET)	±20mA

Continuous Power Dissipation ( $T_A = +70$ °C)	
5-Pin SOT23 (derate 7.1mW/°C above +70°C)	571mW
Operating Temperature Range40°C to	o +125°C
Junction Temperature	+150°C
Storage Temperature Range65°C to	o +150°C
Lead Temperature (soldering, 10s)	
Soldering Temperature (reflow)	+260°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

### **ELECTRICAL CHARACTERISTICS**

 $(V_{CC} = 1V \text{ to } 5.5V, T_A = T_{MIN} \text{ to } T_{MAX}, \text{ unless otherwise specified. Typical values are at } V_{CC} = 5V \text{ and } T_A = +25^{\circ}C.)$  (Note 1)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Supply Voltage Range	Vcc		1.0		5.5	V
		V <sub>CC</sub> ≤ 5.0V		2.6	4.5	
Supply Current	Icc	V <sub>CC</sub> ≤ 3.3V		2	3.5	μΑ
		V <sub>CC</sub> ≤ 2.0V		1.7	2.5	
Van Daget Threehold Assumen	\/	T <sub>A</sub> = +25°C	V <sub>TH</sub> - 1.25%	V <sub>TH</sub> + 1.25%		V
V <sub>CC</sub> Reset Threshold Accuracy	VTH	$T_A = -40^{\circ}\text{C to } + 125^{\circ}\text{C}$	V <sub>TH</sub> - 2.5%		V <sub>TH</sub> + 2.5%	V
Hysteresis	V <sub>H</sub> YST			4 x V <sub>TH</sub>		mV
V <sub>CC</sub> to Reset Delay	t <sub>RD</sub>	V <sub>CC</sub> falling at 1mV/µs		100		μs
Reset Timeout Period	4	C <sub>SRT</sub> = 1500pF	3.00	4.375	5.75	
Reset Timeout Period	t <sub>RP</sub>	C <sub>SRT</sub> = 0		0.275		ms
V <sub>SRT</sub> Ramp Current	IRAMP	V <sub>SRT</sub> = 0 to 0.65V; V <sub>CC</sub> = 1.6V to 5V		240		nA
V <sub>SRT</sub> Ramp Threshold	V <sub>TH-RAMP</sub>	V <sub>CC</sub> = 1.6V to 5V (V <sub>RAMP</sub> rising)		0.65		V
RAMP Threshold Hysteresis		V <sub>RAMP</sub> falling threshold		33		mV
	V <sub>OL</sub>	$V_{CC} \ge 1.0V$ , $I_{SINK} = 50\mu A$	0.0		0.3	V
RESET Output Voltage LOW		$V_{CC} \ge 2.7V$ , $I_{SINK} = 1.2mA$	$2.7V$ , $I_{SINK} = 1.2mA$		0.3	
		$V_{CC} \ge 4.5V$ , $I_{SINK} = 3.2mA$		0.4		
DECET Outrout Vallages I HOLL		V <sub>CC</sub> ≥ 1.8V, I <sub>SOURCE</sub> = 200µA	0.8 x V <sub>C</sub> (	)		
RESET Output Voltage HIGH, (Push-Pull)	VoH	$V_{CC} \ge 2.25V$ , $I_{SOURCE} = 500\mu A$	0.8 x V <sub>C</sub> (	0.8 x V <sub>CC</sub>		V
(Fuer Fuer)		V <sub>CC</sub> ≥ 4.5V, I <sub>SOURCE</sub> = 800µA	0.8 x V <sub>C</sub> (	)		]
RESET Output Leakage Current, (Open-Drain)	I <sub>LKG</sub>	V <sub>CC</sub> > V <sub>TH</sub> , reset not asserted			1.0	μΑ
	V <sub>OH</sub>	V <sub>CC</sub> ≥ 1.0V, I <sub>SOURCE</sub> = 1μA 0.8 x V <sub>CC</sub>				
RESET Output Voltage HIGH		$V_{CC} \ge 1.8V$ , $I_{SOURCE} = 150\mu A$ 0.8 x $V_{CC}$			V	
neser Output voltage nIGH		$V_{CC} \ge 2.7V$ , ISOURCE = $500\mu A$ 0.8 x $V_{CC}$				
		V <sub>CC</sub> ≥ 4.5V, I <sub>SOURCE</sub> = 800µA	0.8 x V <sub>C</sub> (			

### **ELECTRICAL CHARACTERISTICS (continued)**

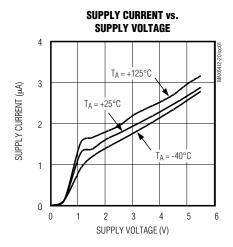
 $(V_{CC} = 1V \text{ to } 5.5V, T_A = T_{MIN} \text{ to } T_{MAX}, \text{ unless otherwise specified. Typical values are at } V_{CC} = 5V \text{ and } T_A = +25^{\circ}C.)$  (Note 1)

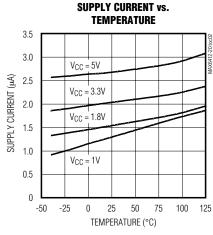
PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
		V <sub>CC</sub> ≥ 1.8V, I <sub>SINK</sub> = 500µA			0.3	
RESET Output Voltage LOW	VoL	$V_{CC} \ge 2.7V$ , $I_{SINK} = 1.2mA$			0.3	V
		V <sub>CC</sub> ≥ 4.5V, I <sub>SINK</sub> = 3.2mA			0.4	
RESET IN Leakage Current					10	nA
RESET IN Threshold	V <sub>RST</sub>	$V_{RST}$ falling, $V_{CC} = 1.6V$ to 5.0V	1.205	1.255		V
	VIL	V 4 0V			0.8	
MD locate	VIH	$V_{CC} > 4.0V$	2.4			
MR Input	VIL	V <sub>CC</sub> < 4.0V			0.3 x V <sub>C</sub> C	V
	VIH		0.7 x V <sub>CC</sub>	;		
MR Minimum Pulse Width			1			μs
MR Glitch Rejection				75		ns
MR to RESET Delay				20	·	ns
MR Pullup Resistance		Pull up to V <sub>CC</sub>	12	20	28	kΩ

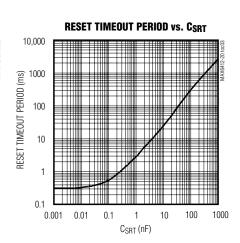
**Note 1:** Devices production tested at  $T_A = +25$ °C. Over temperature limits are guaranteed by design.

## Typical Operating Characteristics

(V<sub>CC</sub> = 5V, C<sub>SRT</sub> = 1500pF,  $T_A$  = +25°C, unless otherwise noted.)

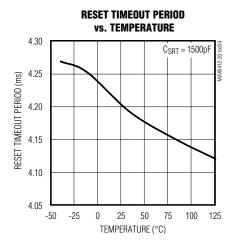


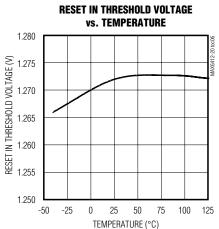


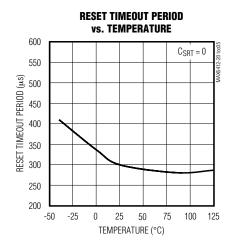


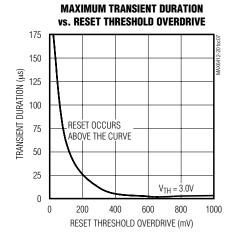
Typical Operating Characteristics (continued)

( $V_{CC} = 5V$ ,  $C_{SRT} = 1500$ pF,  $T_A = +25$ °C, unless otherwise noted.)









### **Pin Description**

	PIN				
MAX6412/ MAX6413/ MAX6414	MAX6415/ MAX6416/ MAX6417	MAX6418/ MAX6419/ MAX6420	NAME	FUNCTION	
1	1	1	RESET	RESET changes from high to low whenever V <sub>CC</sub> or RESET IN drops below the selected reset threshold voltage (V <sub>TH</sub> or V <sub>RESET IN</sub> , respectively) or manual reset is pulled low. RESET remains low for the reset timeout period after all reset conditions are deasserted and then goes high.	
1	ı		RESET	RESET changes from low to high whenever the V <sub>CC</sub> or RESET IN drops below the selected reset threshold voltage (V <sub>TH</sub> or V <sub>RESET IN</sub> ) or manual reset is pulled low. RESET remains high for the reset timeout period after all reset conditions are deasserted and then goes low.	
2	2	2	GND	Ground	
	3	3	RESET IN to the center point of an external resistor-divided network to set the threshold of the externally monitored voltage. See Threshold section.		
3	_	_	Manual Reset Input. Pull this pin low to manually reset the device. Re remains asserted for the reset timeout period after MR is released.		
4	4	4	SRT	Set Reset Timeout Input. Connect a capacitor between SRT and ground to set the timeout period. Determine the period as follows: $t_{RP} = (2.73 \times 10^6) \times C_{SRT} + 275 \mu s \text{ with } t_{RP} \text{ in seconds and } C_{SRT} \text{ in Farads.}$	
5	5	5	Vcc	Supply Voltage and Input for Fixed-Threshold V <sub>CC</sub> Monitor	

## **Detailed Description**

The MAX6412–MAX6420 low-power microprocessor ( $\mu$ P) supervisory circuits provide maximum adjustability for supply-voltage monitoring and reset functionality. In addition, the MAX6412–MAX6420 reset timeout period is adjustable using an external capacitor.

The MAX6412/MAX6413/MAX6414 have factory-trimmed reset threshold voltages in approximately 100mV increments from 1.575V to 5.0V with a manual reset input. The MAX6415/MAX6416/MAX6417 contain a reset threshold that can be adjusted to any voltage above 1.26V using external resistors. The MAX6418/MAX6419/MAX6420 offer both a factory-trimmed reset threshold and an adjustable reset threshold input for dual-voltage monitoring.

A reset signal is asserted when V<sub>CC</sub> and/or RESET IN falls below the preset values or when  $\overline{\text{MR}}$  is asserted. The reset remains asserted for an externally programmed interval after V<sub>CC</sub> and/or RESET IN has risen above the reset threshold or  $\overline{\text{MR}}$  is deasserted.

#### **Reset Output**

The reset output is typically connected to the reset input of a  $\mu P$ . A  $\mu P$ 's reset input starts or restarts the  $\mu P$  in a known state. The MAX6412–MAX6420  $\mu P$  supervisory circuits provide the reset logic to prevent code-execution errors during power-up, power-down, and brownout conditions (see *Typical Operating Circuit*).

For the MAX6413, MAX6416, and MAX6419, RESET changes from low to high whenever  $V_{\rm CC}$  or RESET IN drops below the reset threshold voltages. Once RESET IN and  $V_{\rm CC}$  exceed their respective reset threshold voltage(s), RESET remains high for the reset timeout period, then goes low.

On power-up, once  $V_{CC}$  reaches 1V, RESET is guaranteed to be a logic high. For applications requiring valid reset logic when  $V_{CC}$  is less than 1V, see the section Ensuring a Valid RESET/RESET Output Down to  $V_{CC} = 0V$ .

The active-low RESET output of the remaining supervisors is the inverse of the MAX6413, MAX6416, and MAX6419 active-high RESET output and is guaranteed valid for  $V_{CC} \ge 1V$ .

#### Reset Threshold

The MAX6415–MAX6420 monitor the voltage on RESET IN with an external resistor voltage-divider (Figure 1).

Use the following formula to calculate the externally monitored voltage ( $V_{\mbox{MON\_TH}}$ ):

$$V_{MON\_TH} = V_{RST} \times (R1 + R2)/R2$$

where V<sub>MON\_TH</sub> is the desired reset threshold voltage and V<sub>RST</sub> is the reset input threshold (1.26V). Resistors R1 and R2 can have very high values to minimize current consumption due to low leakage currents. Set R2 to some conveniently high value (1M $\Omega$ , for example) and calculate R1 based on the desired monitored voltage, using the following formula:

$$R1 = R2 \times (V_{MON} T_{H}/V_{RST} - 1) (\Omega)$$

## Manual Reset Input (MAX6412/MAX6413/MAX6414)

Many  $\mu P$ -based products require manual reset capability, allowing the operator, a technician, or external logic circuitry to initiate a reset. A logic low on  $\overline{MR}$  asserts reset. Reset remains asserted while  $\overline{MR}$  is low and for the reset timeout period after  $\overline{MR}$  returns high.

The  $\overline{MR}$  has an internal  $20k\Omega$  pullup resistor so it can be left open if not used. Connect a normally open momentary switch from  $\overline{MR}$  to ground to create a manual reset function (external debounce circuitry is not required for long reset timeout periods).

A manual reset option can easily be implemented with the MAX6415–MAX6420 by connecting a normally open momentary switch in parallel with R2 (Figure 2). When the switch is closed, the voltage on RESET IN goes to zero,

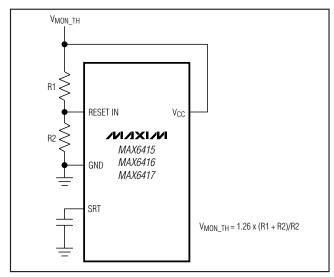


Figure 1. Calculating the Monitored Threshold Voltage (V<sub>MON TH</sub>)

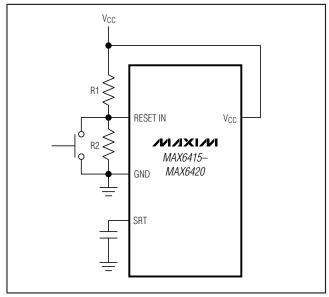


Figure 2. Adding an External Manual Reset Function to the MAX6415–MAX6420

initiating a reset. Similar to the MAX6412/MAX6413/ MAX6414 manual reset, reset remains asserted while the switch is closed and for the reset timeout period after the switch is opened.

## Monitoring Voltages Other than VCC (MAX6415/MAX6416/MAX6417)

The MAX6415/MAX6416/MAX6417 contain an adjustable reset threshold input. These devices can be used to monitor voltages other than V<sub>CC</sub>. Calculate V<sub>MON\_TH</sub> as shown in the *Reset Threshold* section. (See Figure 3.)

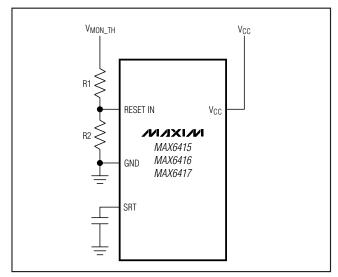


Figure 3. Monitoring External Voltages

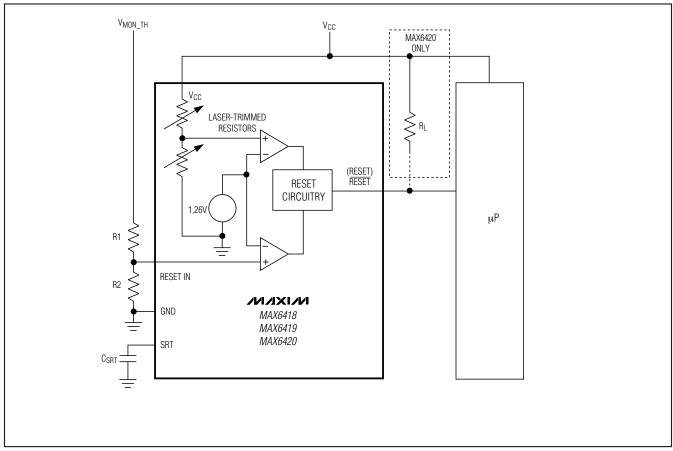


Figure 4. MAX6418/MAX6419/MAX6420 Monitoring Two Voltages

## Dual-Voltage Monitoring (MAX6418/MAX6419/MAX6420)

The MAX6418/MAX6419/MAX6420 contain both factory-trimmed threshold voltages and an adjustable reset threshold input, allowing the monitoring of two voltages, VCC and VMON\_TH (see Figure 4). Reset is asserted when either of the voltages falls below its respective threshold voltage.

## Application Information

#### Selecting a Reset Capacitor

The reset timeout period is adjustable to accommodate a variety of  $\mu P$  applications. Adjust the reset timeout period (tpp) by connecting a capacitor (CSRT) between SRT and ground. Calculate the reset timeout capacitor as follows:

 $C_{SRT} = (t_{RP} - 275\mu s) / (2.73 \times 10^6)$ 

where the is in seconds and CSRT is in Farads

The reset delay time is set by a current/capacitor-controlled ramp compared to an internal 0.65V reference. An internal 240nA ramp current source charges the external capacitor. The charge to the capacitor is cleared when a reset condition is detected. Once the reset condition is removed, the voltage on the capacitor ramps according to the formula: dV/dt = I/C. The CSRT capacitor must ramp to 0.65V to deassert the reset. CSRT must be a low-leakage (<10nA) type capacitor, ceramic is recommended.

### Operating as a Voltage Detector

The MAX6412–MAX6420 can be operated in a voltage detector mode by leaving SRT unconnected. The reset delay times for VCC rising above or falling below the threshold are not significantly different. The reset output is deasserted smoothly without false pulses.

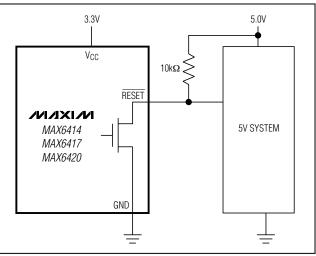


Figure 5. MAX6414/MAX6417/MAX6420 Open-Drain RESET Output Allows use with Multiple Supplies

### Interfacing to Other Voltages for Logic Compatibility

The open-drain outputs of the MAX6414/MAX6417/ MAX6420 can be used to interface to  $\mu Ps$  with other logic levels. As shown in Figure 5, the open-drain output can be connected to voltages from 0 to 5.5V. This allows for easy logic compatibility to various microprocessors.

#### **Negative-Going Vcc Transients**

In addition to issuing a reset to the  $\mu P$  during power-up, power-down, and brownout conditions, these supervisors are relatively immune to short-duration negative-going transients (glitches). The Maximum Transient Duration vs. Reset Threshold Overdrive graph in the *Typical Operating Characteristics* shows this relationship.

The area below the curve of the graph is the region in which these devices typically do not generate a reset pulse. This graph was generated using a negative-going pulse applied to  $V_{\rm CC}$ , starting above the actual reset threshold ( $V_{\rm TH}$ ) and ending below it by the magnitude indicated (reset-threshold overdrive). As the magnitude of the transient decreases (farther below the reset threshold), the maximum allowable pulse width decreases. Typically, a  $V_{\rm CC}$  transient that goes 100mV below the reset threshold and lasts 50 $\mu$ s or less will not cause a reset pulse to be issued.

## Ensuring a Valid RESET or RESET Down to VCC = 0V

When V<sub>CC</sub> falls below 1V, RESET/RESET current sinking (sourcing) capabilities decline drastically. In the case of the MAX6412, MAX6415, and MAX6418, high-

impedance CMOS-logic inputs connected to  $\overline{\text{RESET}}$  can drift to undetermined voltages. This presents no problems in most applications, since most  $\mu\text{Ps}$  and other circuitry do not operate with V<sub>CC</sub> below 1V.

In those applications where  $\overline{\text{RESET}}$  must be valid down to 0, adding a pulldown resistor between  $\overline{\text{RESET}}$  and ground sinks any stray leakage currents, holding  $\overline{\text{RESET}}$  low (Figure 6). The value of the pulldown resistor is not critical;  $100\text{k}\Omega$  is large enough not to load  $\overline{\text{RESET}}$  and small enough to pull  $\overline{\text{RESET}}$  to ground. For applications using the MAX6413, MAX6416, and MAX6419, a  $100\text{k}\Omega$  pullup resistor between RESET and VCC will hold RESET high when VCC falls below 1V (Figure 7). Open-drain  $\overline{\text{RESET}}$  versions are not recommended for applications requiring valid logic for VCC down to 0V.

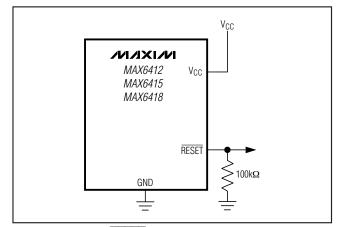


Figure 6. Ensuring  $\overline{RESET}$  Valid to  $V_{CC} = 0V$ 

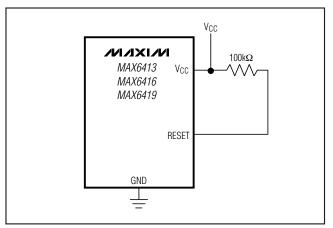


Figure 7. Ensuring RESET Valid to  $V_{CC} = 0V$ 

\_\_ /N/XI/VI

#### **Layout Consideration**

SRT is a precise current source. When developing the layout for the application, be careful to minimize board capacitance and leakage currents around this pin. Traces connected to SRT should be kept as short as possible. Traces carrying high-speed digital signals and traces with large voltage potentials should be routed as far from SRT as possible. Leakage current and stray capacitance (e.g., a scope probe) at this pin could cause errors in the reset timeout period. When evaluating these parts, use clean prototype boards to ensure accurate reset periods.

RESET IN is a high-impedance input, which is typically driven by a high-impedance resistor-divider network (e.g.,  $1M\Omega$  to  $10M\Omega$ ). Minimize coupling to transient signals by keeping the connections to this input short. Any DC leakage current at RESET IN (e.g., a scope probe) causes errors in the programmed reset threshold.

## **Chip Information**

TRANSISTOR COUNT: 325 PROCESS: BICMOS

**Table 1. Reset Voltages Suffix Table** 

SUFFIX	MIN	TYP	MAX
16	1.536	1.575	1.614
17	1.623	1.665	1.707
18	1.755	1.800	1.845
19	1.853	1.900	1.948
20	1.950	2.000	2.050
21	2.048	2.100	2.153
22	2.133	2.188	2.243
23	2.313	2.313	2.371
24	2.340	2.400	2.460
25	2.438	2.500	2.563
26	2.559	2.625	2.691
27	2.633	2.700	2.768
28	2.730	2.800	2.870
29	2.852	2.925	2.998
30	2.925	3.000	3.075
31	2.998	3.075	3.152
32	3.120	3.200	3.280
33	3.218	3.300	3.383
34	3.315	3.400	3.485
35	3.413	3.500	3.558
36	3.510	3.600	3.690
37	3.608	3.700	3.793
38	3.705	3.800	3.895
39	3.803	3.900	3.998
40	3.900	4.000	4.100
41	3.998	4.100	4.203
42	4.095	4.200	4.305
43	4.193	4.300	4.408
44	4.266	4.375	4.484
45	4.388	4.500	4.613
46	4.509	4.625	4.741
47	4.583	4.700	4.818
48	4.680	4.800	4.920
49	4.778	4.900	5.023
50	4.875	5.000	5.125

## Standard Versions Table

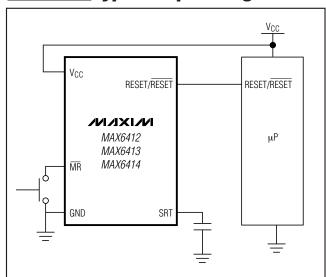
PART*	TOP MARK
MAX6412UK16-T	ADVY
MAX6412UK22-T	ADWA
MAX6412UK26-T	ADWC
MAX6412UK29-T	ADWD
MAX6412UK46-T	ADWG
MAX6413UK16-T	ADWI
MAX6413UK22-T	ADWK
MAX6413UK26-T	ADWM
MAX6413UK29-T	ADWN
MAX6413UK46-T	ADWQ
MAX6414UK16-T	ADWS
MAX6414UK22-T	ADWU
MAX6414UK26-T	ADWW
MAX6414UK29-T	ADWX
MAX6414UK46-T	ADXA
MAX6415UK-T	ADZO
MAX6416UK-T	ADZP
MAX6417UK-T	ADZQ
MAX6418UK16-T	ADYG
MAX6418UK22-T	ADYI
MAX6418UK26-T	ADYK
MAX6418UK29-T	ADYL
MAX6418UK46-T	ADYO
MAX6419UK16-T	ADYQ
MAX6419UK22-T	ADYS
MAX6419UK26-T	ADYU
MAX6419UK29-T	ADYV
MAX6419UK46-T	ADYY
MAX6420UK16-T	ADZA
MAX6420UK22-T	ADZC
MAX6420UK26-T	ADZE
MAX6420UK29-T	ADZF
MAX6420UK46-T	ADZI
*Sample Stock is generally	held on all standard versions

<sup>\*</sup>Sample Stock is generally held on all standard versions. Contact factory for availability of nonstandard versions.

### **Selector Guide**

PART	FIXED V <sub>TH</sub>	MANUAL RESET	RESET IN	PUSH-PULL RESET	PUSH-PULL RESET	OPEN-DRAIN RESET
MAX6412	<b>v</b>	~	_	~	_	_
MAX6413	<i>V</i>	V	_	_	V	_
MAX6414	V	V	_	_	_	V
MAX6415	_	_	V	V	_	_
MAX6416	_	_	~	_	~	_
MAX6417	_	_	V	_	_	~
MAX6418	<i>V</i>	_	V	V	_	_
MAX6419	<i>V</i>	_	V	_	V	_
MAX6420	V	_	~	_	_	V

## **Typical Operating Circuit**



### Package Information

For the latest package outline information and land patterns, go to <a href="www.maxim-ic.com/packages">www.maxim-ic.com/packages</a>. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

PACKAGE TYPE	PACKAGE CODE	DOCUMENT NO.
5 SOT23	U5-2	<u>21-0057</u>

### **Revision History**

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
0	01/02	Initial release	_
1	8/03	Corrected top marks.	10
2	12/05	Added lead-free information in Ordering Information.	1
3	3/10	Deleted RESET in Hysteresis parameter in the <i>Electrical Characteristics</i> table.	3

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